

NICKEL PLATING PROCESSES

NOVALYTE SN-SB-74

Sulfamate nickel plating process is suitable for recording, printing, electroforming, aerospace and electronic industries. The mechanical properties of the deposit such as hardness, ductility, tensile strength and internal stress can be closely controlled.

ALDOLYTE 500-BN

A three-part coumarin-free system that produces a brilliant, level, ductile, and compressively stressed deposit which is ideal as the precursor for chromium. The process responds to either cathode rod or air agitation.

ALDOLYTE 500-SB

A coumarin-free and sulfur-free process, which produces semi-bright and highly ductile deposits with remarkable leveling power. These deposits are ideally suited as the initial layer of a duplex system.

ALDOLYTE ACNS-570

A highly stable multi-purpose high-speed process, which deposits a bright nickel-phosphorus, alloy coating by chemical reduction on steel surface without impressed electric current.